

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

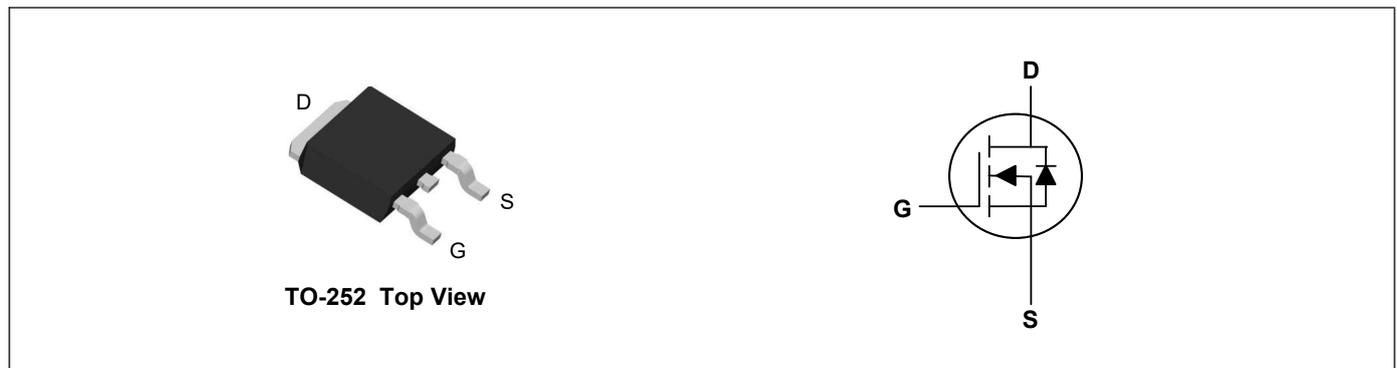
Product Summary



V_{DS}	250	V
I_D	17	A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	265	m Ω

Applications

- High Frequency Point-of-Load, Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch, LCD/LED Display inverter



Absolute Maximum Ratings($T_C=25^{\circ}C$, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	250	V
Gate-Source Voltage	V_{GS}	± 25	V
Continuous Drain Current	$I_D@T_C=25^{\circ}C$	17	A
Continuous Drain Current	$I_D@T_C=70^{\circ}C$	13.7	A
Pulsed Drain Current	I_{DM}	68.6	A
Total Power Dissipation	$P_D@T_C=25^{\circ}C$	125	W
Total Power Dissipation	$P_D@T_C=70^{\circ}C$	80	W
Storage Temperature Range	T_{STG}	-55 to 150	$^{\circ}C$
Operating Junction Temperature Range	T_J	-55 to 150	$^{\circ}C$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	---	1	$^{\circ}C/W$

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	250	---	---	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =7A	---	220	265	mΩ
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250uA	2	---	4	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =200V, V _{GS} =0V, T _J =25°C	---	---	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±25V, V _{DS} =0V	---	---	±100	nA
Gate Resistance	R _g	V _{DS} =0V, V _{GS} =0V, f=1MHz	---	2.3	---	Ω
Total Gate Charge	Q _g	V _{DS} =200V, V _{GS} =10V, I _D =14A	---	70.8	---	nC
Gate-Source Charge	Q _{gs}		---	16.2	---	
Gate-Drain Charge	Q _{gd}		---	23.9	---	
Turn-On Delay Time	T _{d(on)}	V _{DS} =125V, R _L =18Ω, V _{GS} =10V, R _G =25Ω	---	53	---	ns
Rise Time	T _r		---	62.6	---	
Turn-Off Delay Time	T _{d(off)}		---	198	---	
Fall Time	T _f		---	83.5	---	
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1MHz	---	3480	---	pF
Output Capacitance	C _{oss}		---	112	---	
Reverse Transfer Capacitance	C _{rss}		---	51	---	

Drain-Source Diode Characteristics

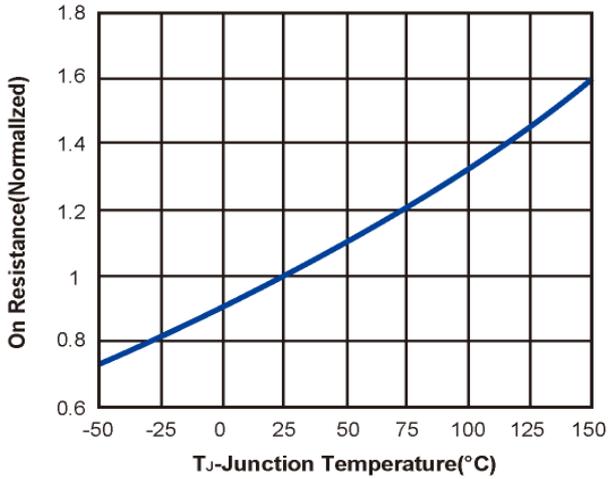
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode Forward Voltage ²	V _{SD}	V _{GS} =0V, I _S =1A, T _J =25°C	---	0.74	1	V

Note:

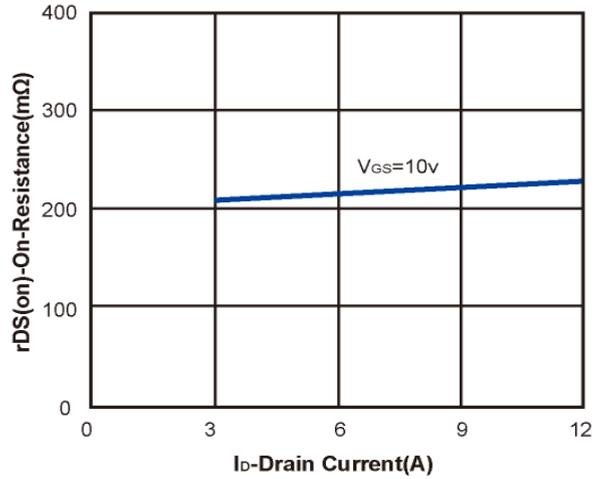
- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%

Typical Characteristics

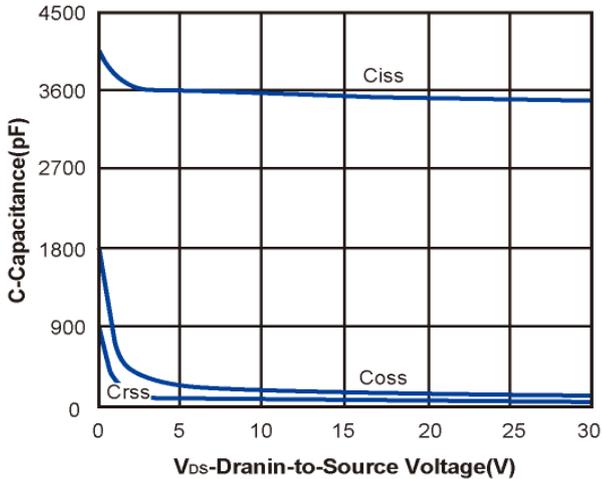
On Resistance vs. Junction Temperature



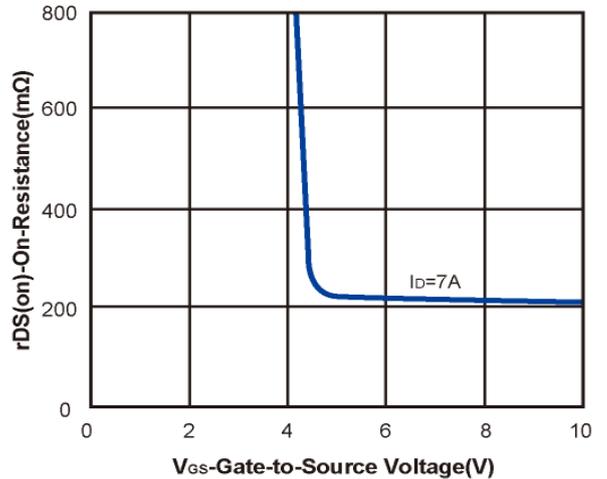
On Resistance vs. Drain Current



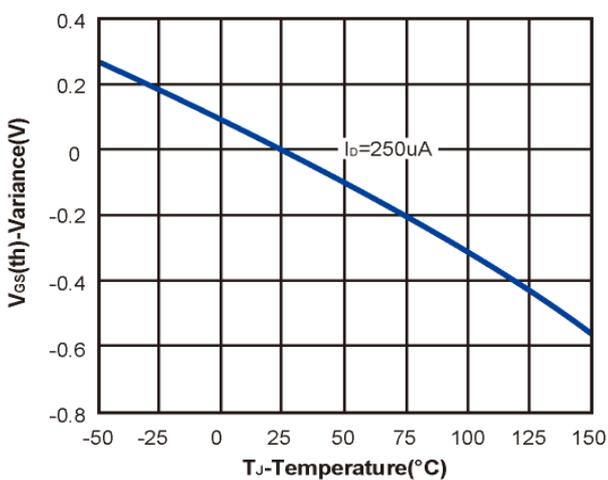
Capacitance



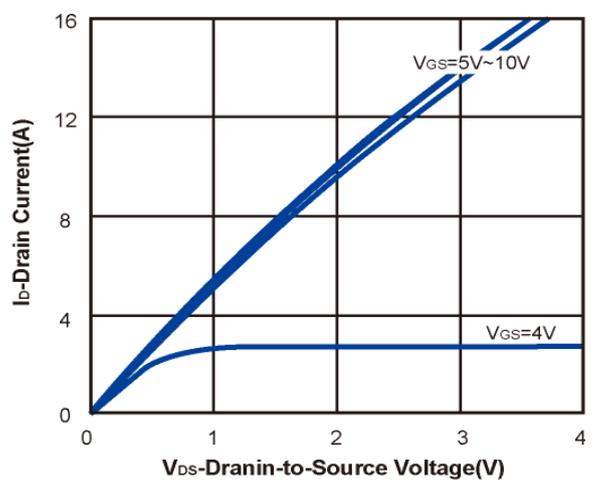
On Resistance vs. Gate-to-Source Voltage

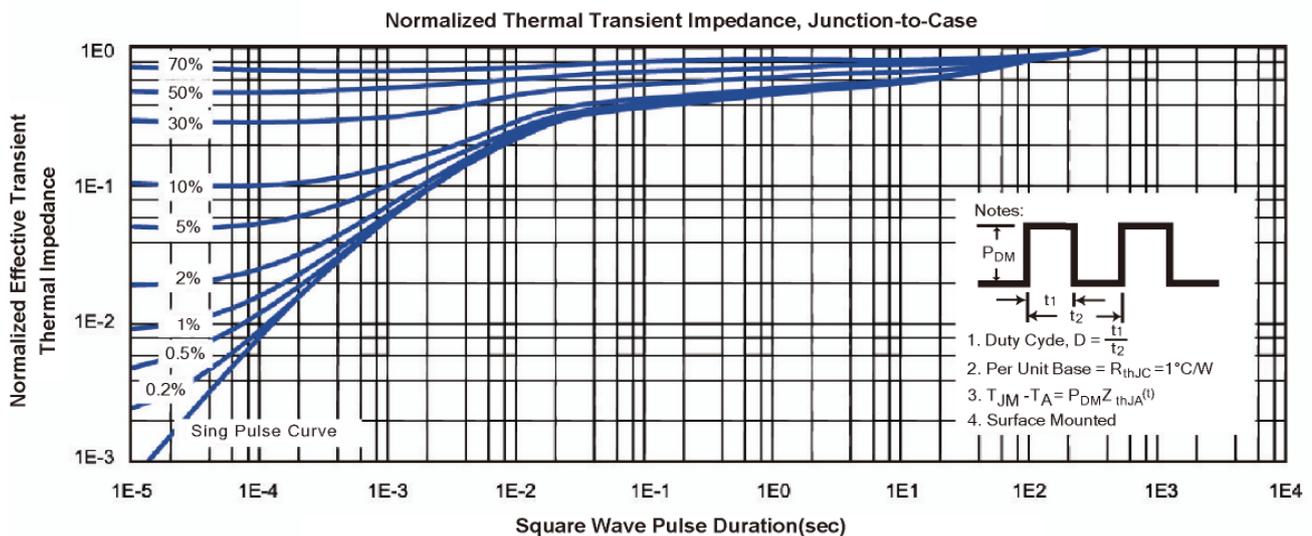
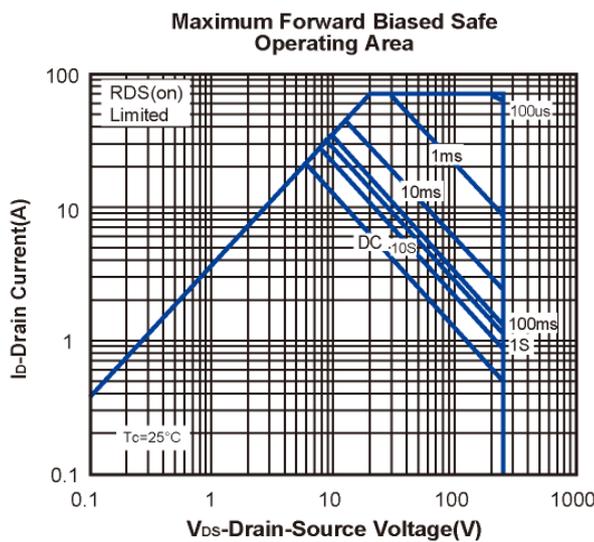
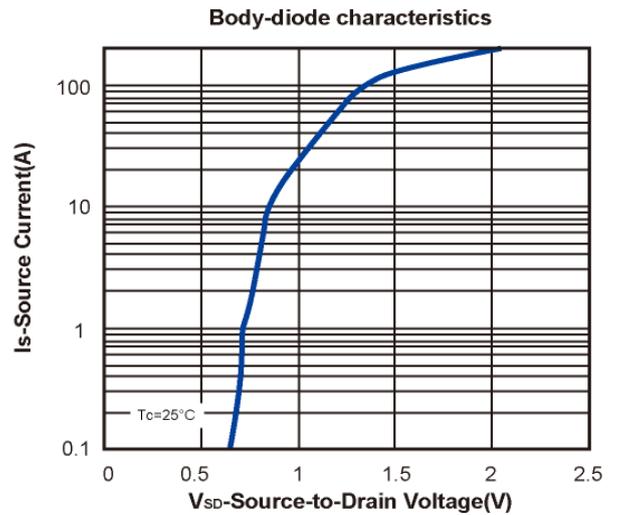
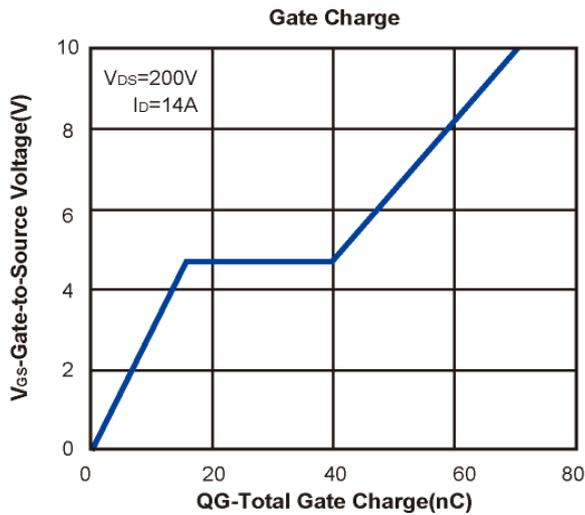


Threshold Voltage

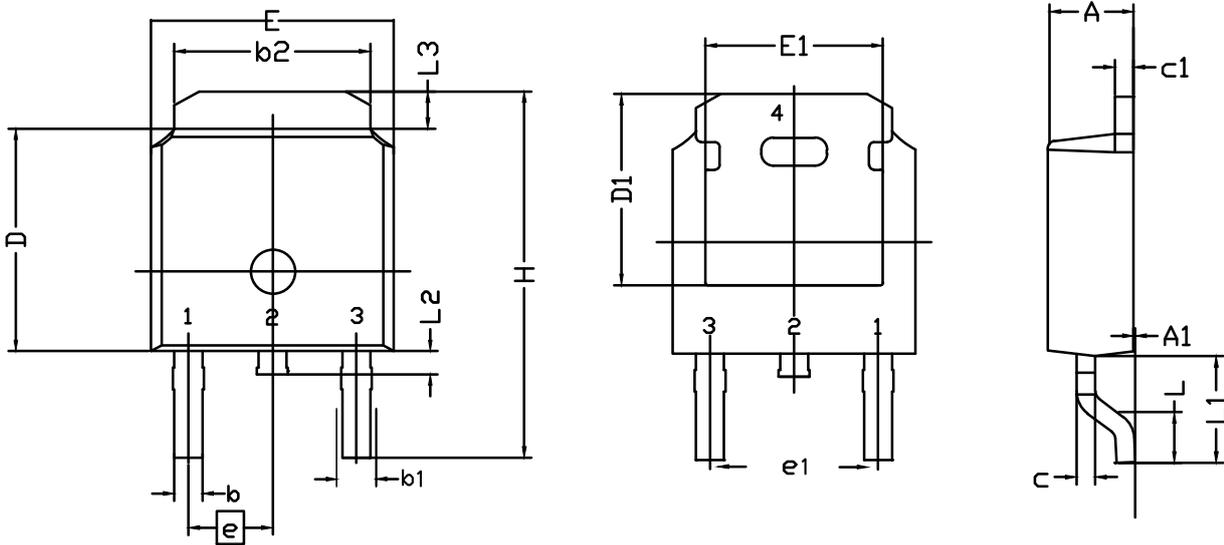


On-Region Characteristics





TO-252 Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	2.20	2.30	2.38	E	6.40	6.60	6.731
A ₁	0.00	0.10	0.20	E ₁	4.40	--	--
b	0.64	0.76	0.89	e	2.286 BSC		
b ₁	0.77	0.85	1.14	e ₁	4.572 BSC		
b ₂	5.00	5.33	5.46	H	9.40	10.00	10.40
c	0.458	0.508	0.610	L	1.40	1.52	1.77
C ₁	0.458	0.508	0.620	L ₁	--	2.743	--
D	5.98	6.10	6.223	L ₂	0.60	0.80	1.01
D ₁	5.20	5.25	5.38	L ₃	0.90	1.06	1.25